

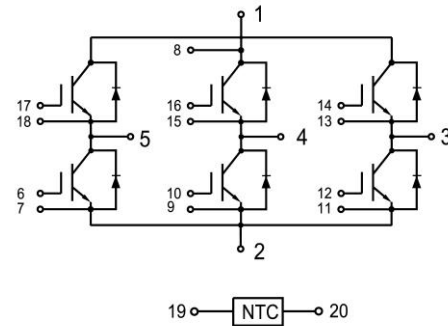


GT100FF120A8H

IGBT Module

Features:

- Field Stop Trench Gate IGBT
- Short Circuit Rated >10 μ s
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested (2 $\times$ I_c)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement



Applications:

- High Power Converters
- Motor Drives
- UPS Systems

IGBT, Inverter

Maximum Rated Values (T_C=25°C unless otherwise specified)

V _{CES}	Collector-Emitter Blocking Voltage		1200	V
V _{GES}	Gate-Emitter Voltage		±20	V
I _C	Continuous Collector Current	T _C =100°C	100	A
		T _C =25°C	200	A
I _{CM}	Peak Collector Current Repetitive	t _p =1ms	200	A
P _D	Maximum Power Dissipation (IGBT)	T _C =25°C T _{Jmax} =175°C	700	W



Electrical Characteristics of IGBT ($T_C=25^{\circ}\text{C}$ unless otherwise specified)

Static Characteristics

Symbol	Description	Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=2.4\text{mA}$, $V_{CE}=V_{GE}$	5.0	5.7	6.6	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=100\text{A}$, $V_{GE}=15\text{V}$	$T_J=25^{\circ}\text{C}$	1.65	1.90	V
			$T_J=125^{\circ}\text{C}$	2.00		V
			$T_J=150^{\circ}\text{C}$	2.10		V
I_{CES}	Collector-Emitter Leakage Current	$V_{GE}=0\text{V}$, $V_{CE}=V_{CES}$, $T_J=25^{\circ}\text{C}$			1	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=\pm 20\text{V}$, $V_{CE}=0\text{V}$, $T_J=25^{\circ}\text{C}$			± 200	nA
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}$, $V_{GE}=0\text{V}$, $f=100\text{kHz}$		11.46		nF
C_{oes}	Output Capacitance			1.52		nF
C_{res}	Reveres Transfer Capacitance			0.74		nF

Switching Characteristics

t _{d(on)}	Turn-on Delay Time	V _{CC} =600V, I _c =100A, R _{Gon} =1Ω, V _{GE} =±15V, Inductive Load	T _J =25℃		152		ns
			T _J =125℃		168		
			T _J =150℃		172		
t _r	Rise Time		T _J =25℃		32		ns
			T _J =125℃		40		
			T _J =150℃		42		
t _{d(off)}	Turn-off Delay Time	V _{CC} =600V, I _c =100A, R _{Goff} =1Ω, V _{GE} =±15V, Inductive Load	T _J =25℃		302		ns
			T _J =125℃		348		
			T _J =150℃		352		
t _f	Fall Time		T _J =25℃		158		ns
			T _J =125℃		250		
			T _J =150℃		250		
E _{on}	Turn-on Switching Loss	V _{CC} =600V, I _c =100A, R _{Gon} =1Ω, V _{GE} =±15V, di/dt=2061A/μs(T _J =150℃), Inductive Load	T _J =25℃		2.70		mJ
			T _J =125℃		4.70		
			T _J =150℃		5.64		



E _{off}	Turn-off Switching Loss	V _{CC} =600V, I _C =100A, R _{Goff} =1Ω, V _{GE} =±15V, du/dt=5171V/μs(T _J =150°C), Inductive Load	T _J =25°C		7.83		mJ
			T _J =125°C		10.18		
			T _J =150°C		10.81		
Q _g	Total Gate Charge	V _{GE} =+15V...-15V	T _J =25°C		2912		nC
R _{G(int)}	Internal Gate Resistor		T _J =25°C		5.5		Ω
SCSOA	V _{CC} =600V, V _{GE} =+/-15V, R _{Gon} =1Ω, R _{Goff} =1Ω, T _J =25°C			10			μs
R _{θJC}	Thermal Resistance: Junction-To-Case (per IGBT)					0.21	°C/W

Diode, Inverter

Maximum Rated Values (T_C=25°C unless otherwise specified)

V _{RRM}	Repetitive Peak Reverse Voltage	T _J =25°C	1200	V
I _F	Diode Continuous Forward Current	T _C =100°C	100	A
I _{FM}	Peak FWD Current Repetitive	t _p =1ms	200	A

Electrical Characteristics of FWD (T_C=25°C unless otherwise specified)

Symbol	Description	Conditions		Min.	Typ.	Max.	Units
V _{FM}	Forward Voltage	I _F =100A	T _J =25°C		1.65		V
			T _J =125°C		1.80		
			T _J =150°C		1.75		
t _{rr}	Reverse Recovery Time	I _F =100A, -diF/dt=2356A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C		138		ns
			T _J =125°C		182		
			T _J =150°C		212		
I _{rr}	Peak Reverse Recovery Current		T _J =25°C		136		A
			T _J =125°C		155		
			T _J =150°C		159		
Q _{rr}	Reverse Recovery Charge		T _J =25°C		10.6		μC
			T _J =125°C		15.4		
			T _J =150°C		17.5		



E _{rec}	Reverse Recovery Energy	I _F =100A, -diF/dt=2356A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C		4.98		mJ
			T _J =125°C		6.67		
			T _J =150°C		7.59		
R _{θJC}	Thermal Resistance: Junction-To-Case (per Diode)					0.33	°C/W

NTC Characteristics

Symbol	Conditions	Min.	Typ.	Max.	Units
R ₂₅	T _C =25°C		5		kΩ
△ R/R	T _C =100°C, R ₁₀₀ =465Ω			±5	%
P ₂₅	T _C =25°C			10	mW
B _{25/50}	R ₂ =R ₂₅ exp[B _{25/50} (1/T ₂ -1/(298.15K))]		3380		K
B _{25/80}	R ₂ =R ₂₅ exp[B _{25/80} (1/T ₂ -1/(298.15K))]		3440		K
B _{25/100}	R ₂ =R ₂₅ exp[B _{25/100} (1/T ₂ -1/(298.15K))]		3545		K

Module

Symbol	Description	Conditions	Min.	Typ.	Max.	Units
V _{iso}	Isolation Voltage (All Terminals Shorted)	f=50Hz, 30s	4500			V
T _J	Maximum Junction Temperature				175	°C
T _{JOP}	Maximum Operating Junction Temperature Range		-40		+150	°C
T _{stg}	Storage Temperature		-40		+150	°C
CTI	Comparative Tracking Index		200			
R _{θCS}	Case-To-Sink Thermally (Conductive Grease Applied)				0.03	°C/W
T	Power Terminals Screw:M6		3.0		6.0	N·m
T	Mounting Screw:M5		3.0		6.0	N·m
G	Weight			390		g



Ordering Information Table

Device code	G	T	100	FF	120	A8	H
	①	②	③	④	⑤	⑥	⑦

- ① - IGBT Module
- ② - Trench, Low Switching Losses IGBT
- ③ - Rated Current (100=100A)
- ④ - Circuit Configuration: FF (Full Bridge)
- ⑤ - Rated Voltage (120=1200V)
- ⑥ - Package Type
- ⑦ - Test Level (Pass the Important Reliability Test-Industrial Grade)

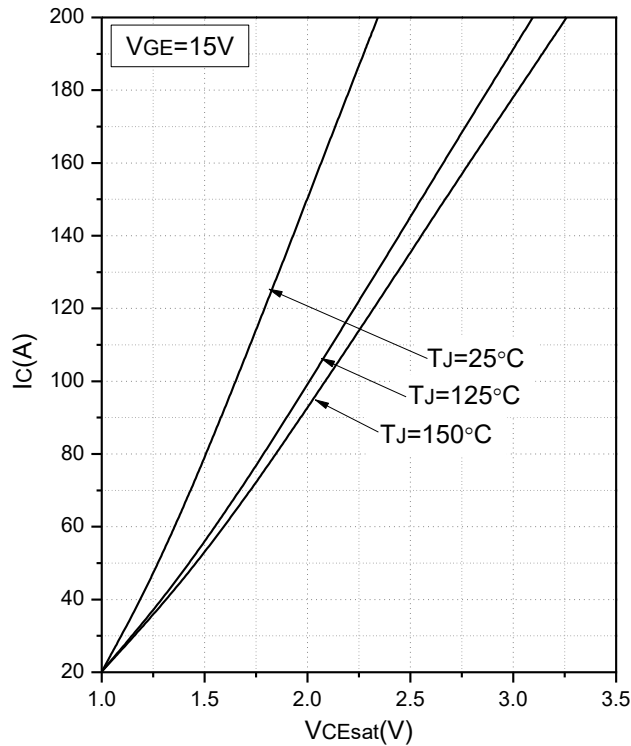


Fig.1 Typical Saturation Voltage Characteristics

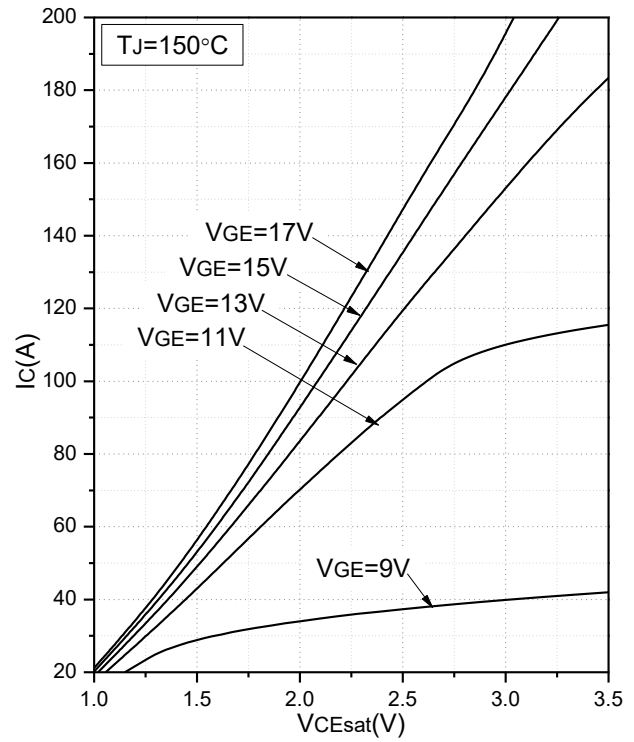


Fig.2 Typical Output Characteristics

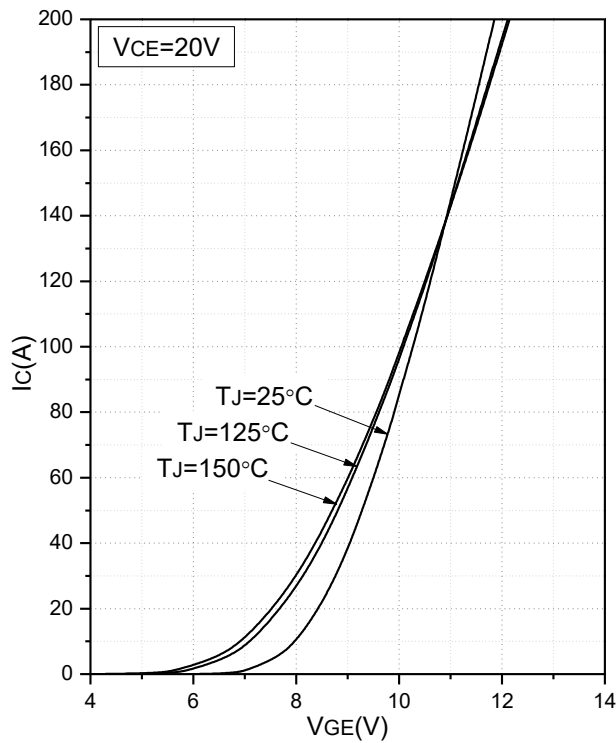


Fig.3 Transfer Characteristics

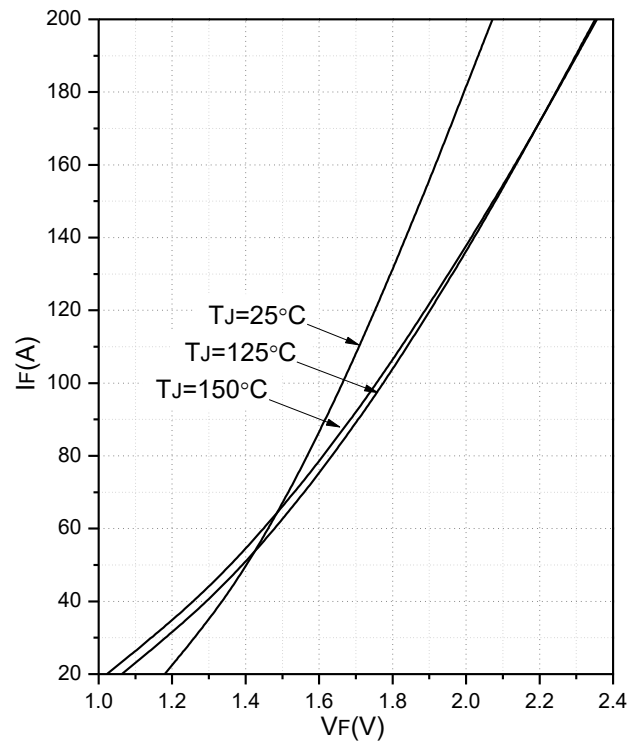


Fig.4 Forward Characteristics of Diode

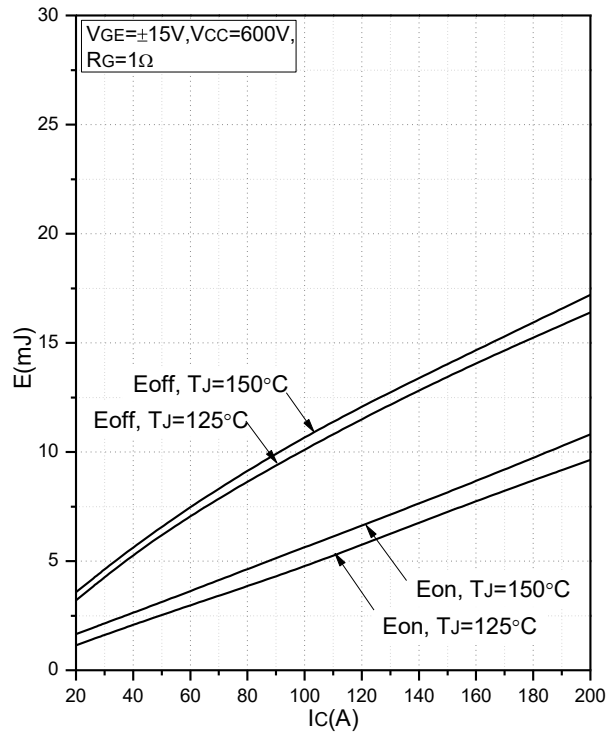


Fig.5 Typical Switching Loss vs. Collector Current

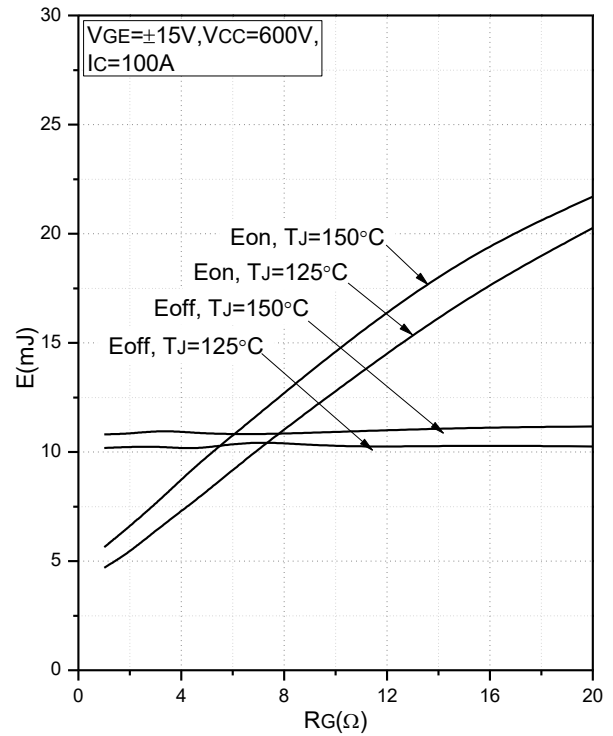


Fig.6 Typical Switching Loss vs. Gate Resistance

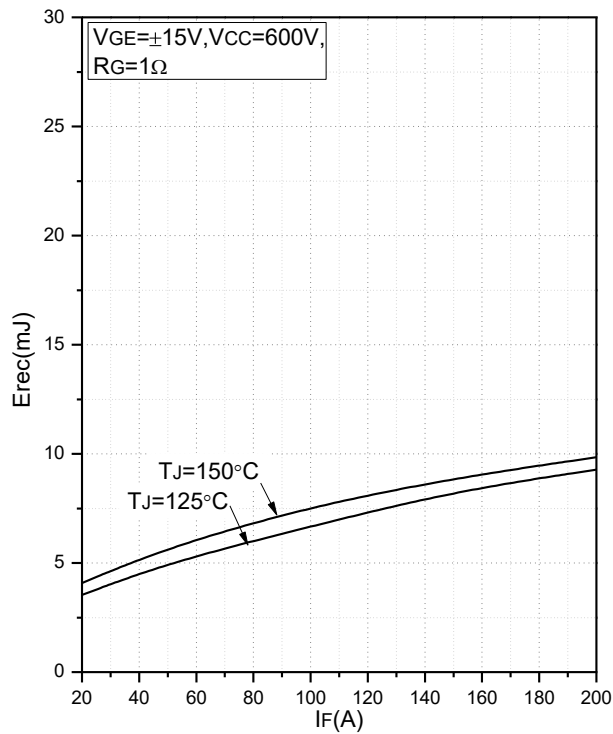


Fig.7 Typical Switching Loss vs. Forward Current

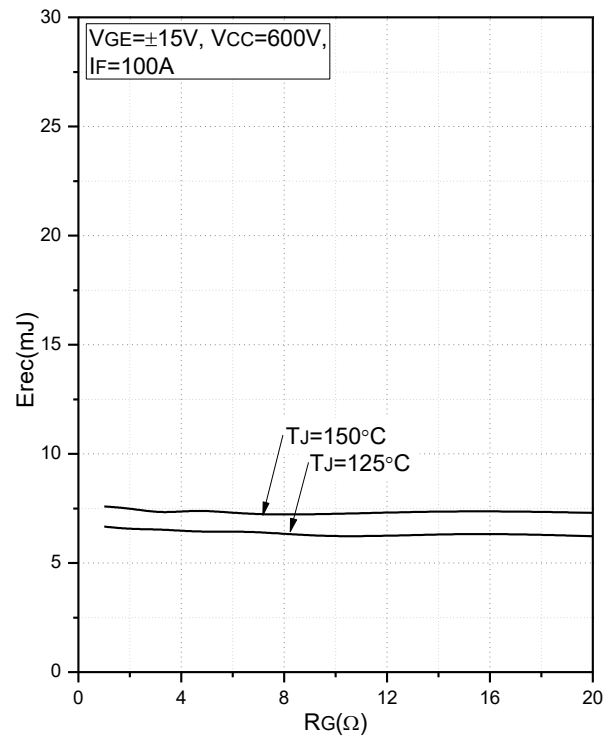
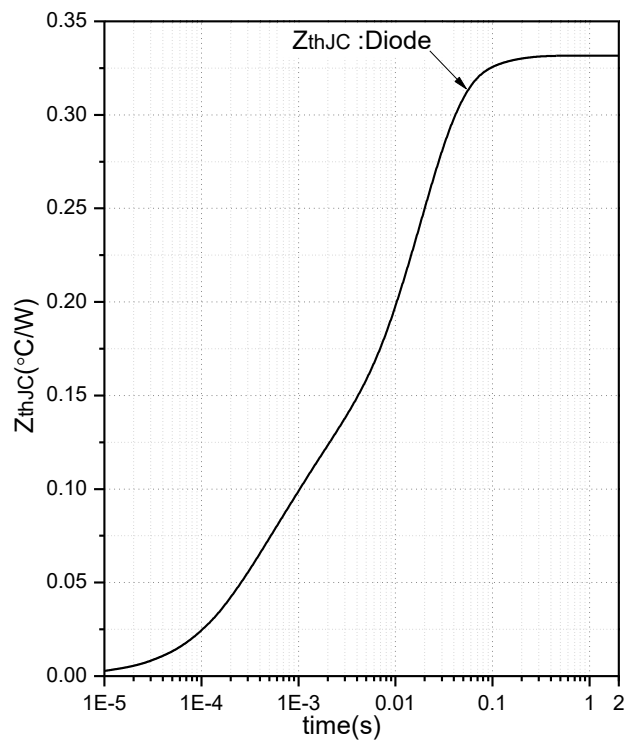
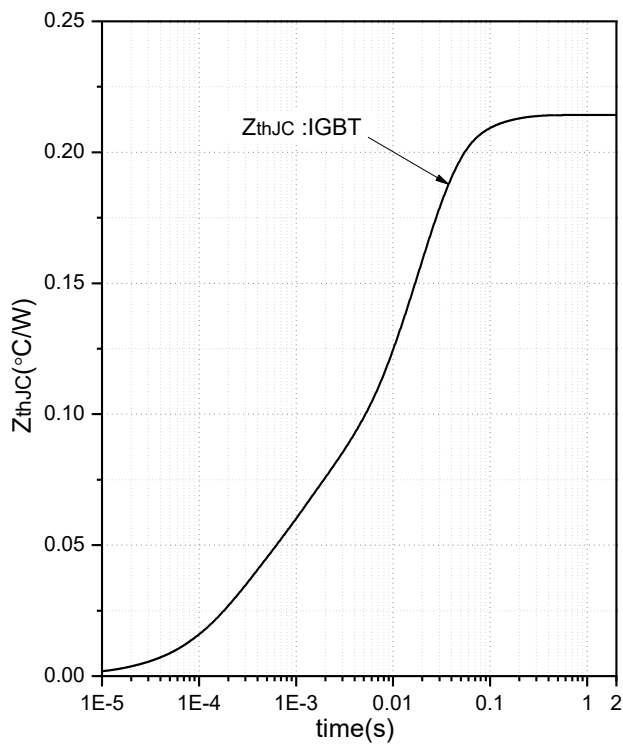
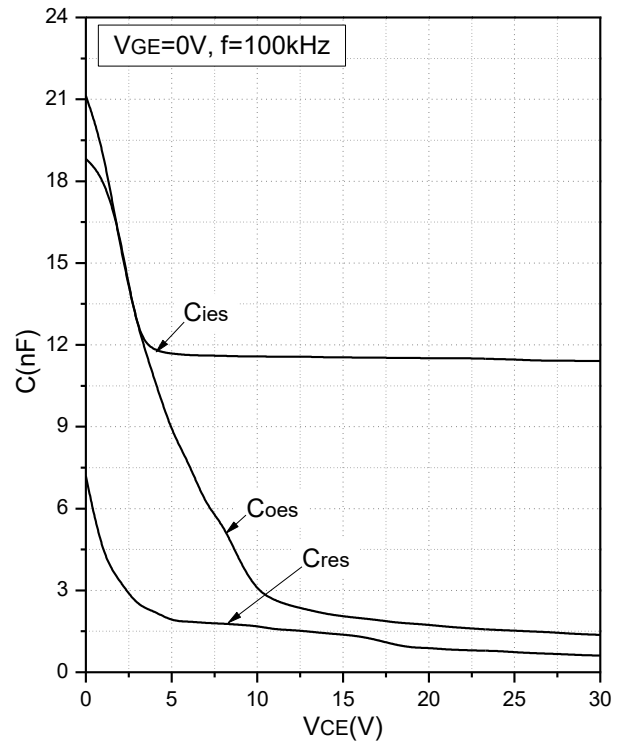
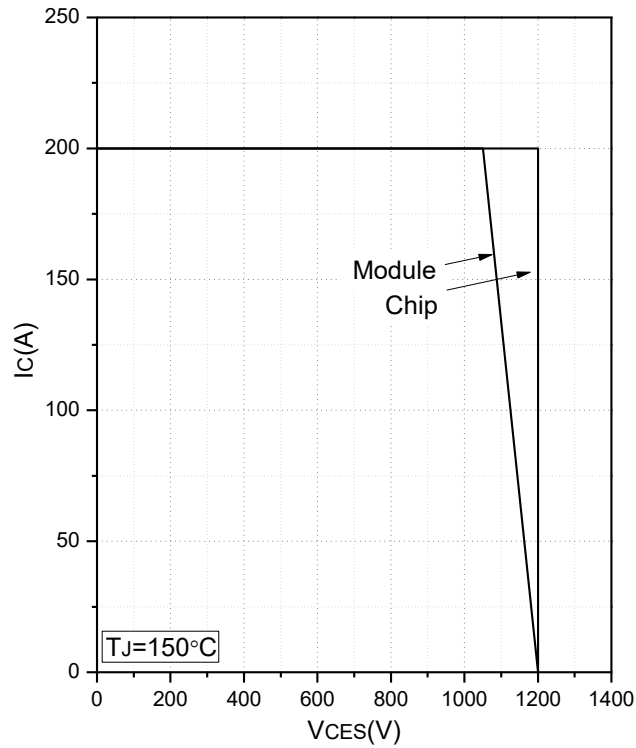


Fig.8 Typical Switching Loss vs. Gate Resistance



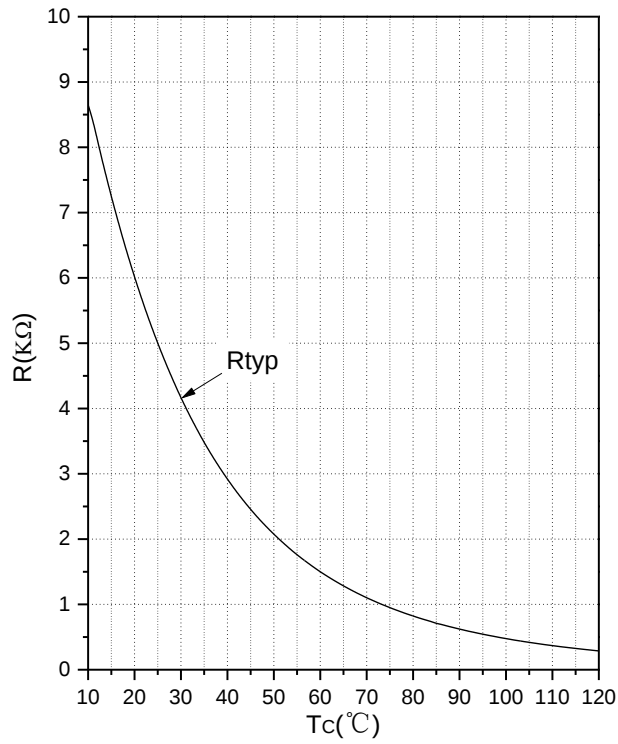
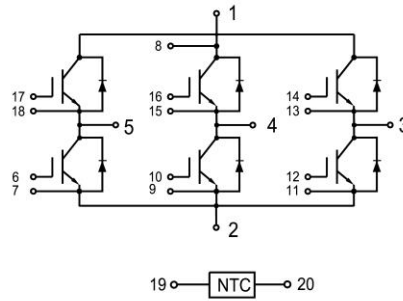


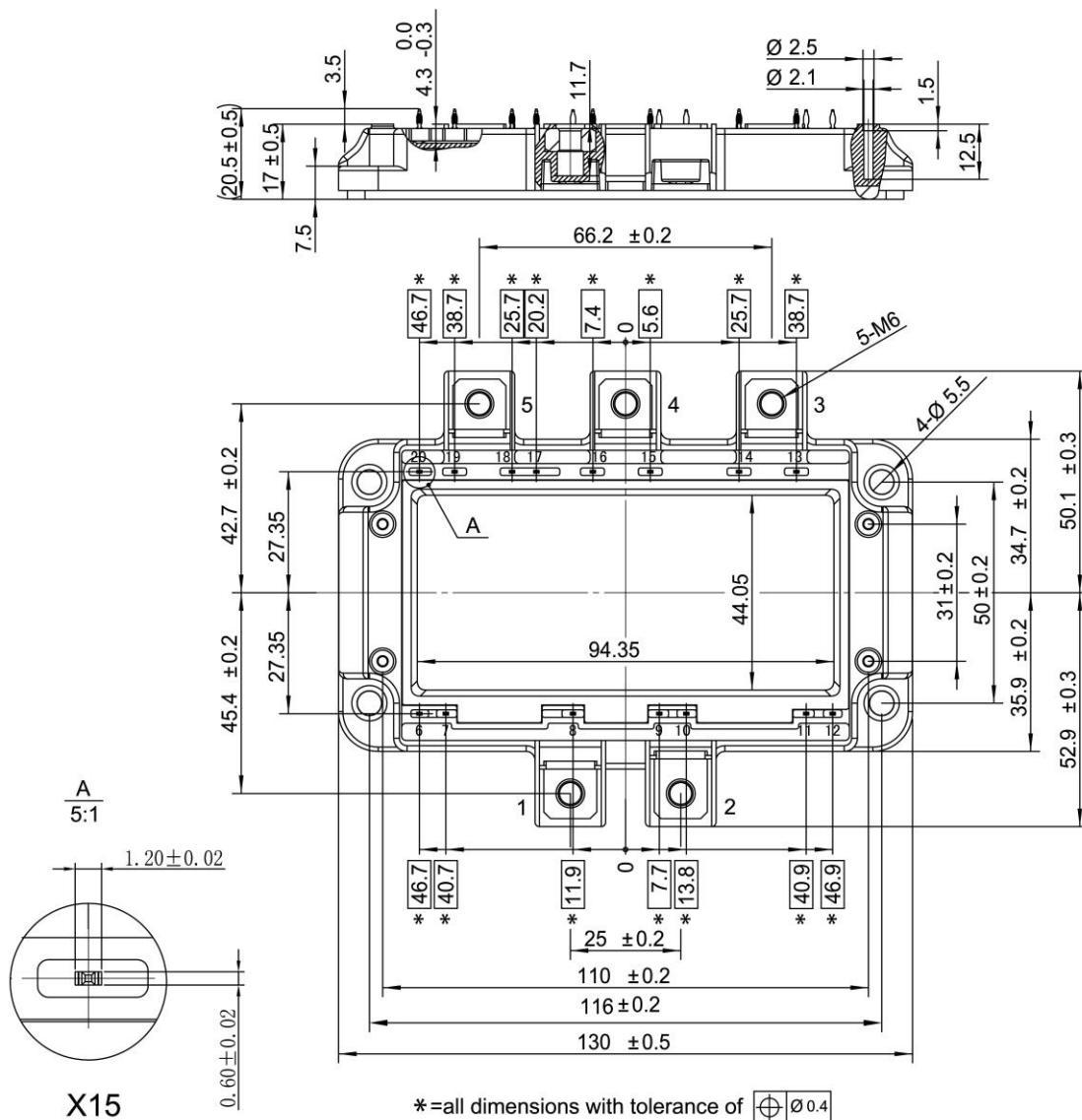
Fig.13 NTC Temperature Characteristics



Internal Circuit:



Package Outline (Unit: mm):





Date	Revision	Notes
07/15/2024	A	Final Version

Announcement

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